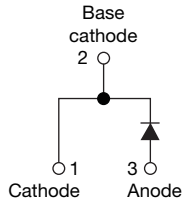


Hyperfast Rectifier, 8 A FRED Pt[®]


2L TO-220AC

2L TO-220 FULL-PAK

VS-ETH0806-M3

VS-ETH0806FP-M3

FEATURES

- Hyperfast soft recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Fully isolated package ($V_{INS} = 2500 V_{RMS}$)
- True 2 pin package
- Designed and qualified according to JEDEC[®]-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE

DESCRIPTION / APPLICATIONS

Hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

PRODUCT SUMMARY

| | |
|-----------------|--------------------------|
| Package | 2L TO-220AC, 2L TO-220FP |
| $I_{F(AV)}$ | 8 A |
| V_R | 600 V |
| V_F at I_F | 1.3 V |
| t_{rr} (typ.) | 16 ns |
| T_J max. | 175 °C |
| Diode variation | Single die |

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|---|----------------|--|-------------|-------|
| Peak repetitive reverse voltage | V_{RRM} | | 600 | V |
| Average rectified forward current in DC | $I_{F(AV)}$ | $T_C = 146\text{ °C}$ $T_C = 114\text{ °C}$ | 8 | A |
| Non-repetitive peak surge current | I_{FSM} | $T_J = 25\text{ °C}$ | 80 | A |
| Repetitive peak surge current Square wave 20 kHz duty cycle (50 %) | I_{FRM} | $T_C = 137\text{ °C}$ $T_C = 96\text{ °C}$ | 16 | A |
| Operating junction and storage temperatures | T_J, T_{Stg} | | -65 to +175 | °C |

ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|--|---------------|---|------|------------|--------------|---------------|
| Breakdown voltage, blocking voltage | V_{BR}, V_R | $I_R = 100\text{ }\mu\text{A}$ | 600 | - | - | V |
| Forward voltage | V_F | $I_F = 8\text{ A}$ $I_F = 8\text{ A}, T_J = 150\text{ °C}$ | - | 2.0 1.3 | 2.65 1.85 | V |
| Reverse leakage current | I_R | $V_R = V_R$ rated $T_J = 150\text{ °C}, V_R = V_R$ rated | - | 0.02 15 | 12 100 | μA |
| Junction capacitance | C_T | $V_R = 600\text{ V}$ | - | 6 | - | pF |
| Series inductance | L_S | Measured lead to lead 5 mm from package body | - | 8 | - | nH |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|------------------|--|-------------------------|------|------|-------|----|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Reverse recovery time | t _{rr} | I _F = 1 A, di _F /dt = 100 A/μs, V _R = 30 V | - | 16 | 23 | ns | |
| | | I _F = 8 A, di _F /dt = 100 A/μs, V _R = 30 V | - | 20 | 28 | | |
| | | T _J = 25 °C | - | 21 | - | | |
| | | T _J = 125 °C | - | 39 | - | | |
| Peak recovery current | I _{RRM} | T _J = 25 °C | - | 3 | - | A | |
| | | T _J = 125 °C | - | 5 | - | | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | - | 36 | - | nC | |
| | | T _J = 125 °C | - | 108 | - | | |
| Reverse recovery time | t _{rr} | I _F = 8 A di _F /dt = 600 A/μs V _R = 390 V | - | 30 | - | ns | |
| Peak recovery current | I _{RRM} | | T _J = 125 °C | - | 13 | - | A |
| Reverse recovery charge | Q _{rr} | | T _J = 125 °C | - | 205 | - | nC |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|--|-----------------------------------|--|-----------|------|------------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -65 | - | 175 | °C |
| Thermal resistance, junction to case FULL-PAK | R _{thJC} | | - | 2.0 | 2.6 | °C/W |
| | | | - | 4.6 | 5.5 | |
| Thermal resistance, junction to ambient | R _{thJA} | Typical socket mount | - | - | 70 | |
| Typical thermal resistance, case to heatsink | R _{thCS} | Mounting surface, flat, smooth and greased | - | 0.5 | - | |
| Weight | | | - | 2 | - | g |
| | | | - | 0.07 | - | oz. |
| Mounting torque | | | 6 (5) | - | 12 (10) | kgf · cm (lbf · in) |
| Marking device | | Case style 2L TO-220AC | ETH0806 | | | |
| | | Case style 2L TO-220 FULL-PAK | ETH0806FP | | | |

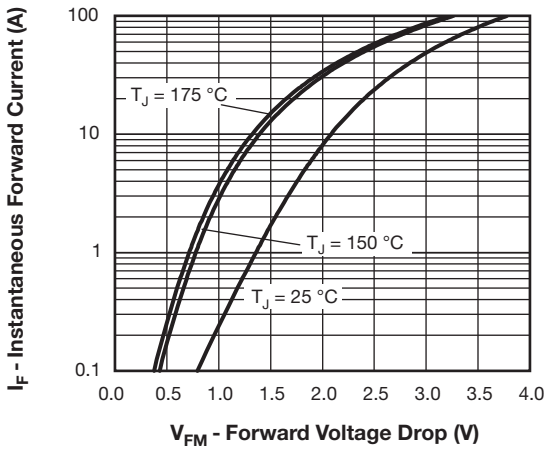


Fig. 1 - Typical Forward Voltage Drop Characteristics

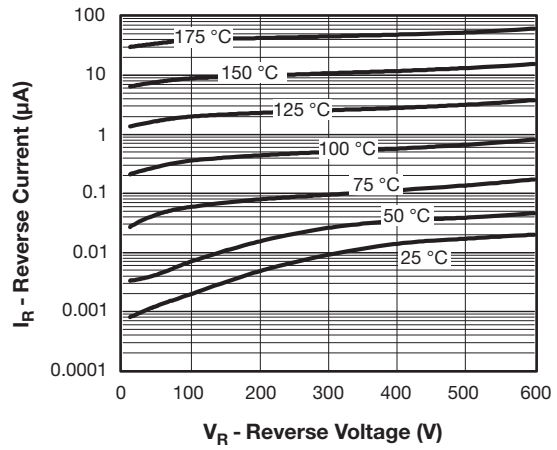


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

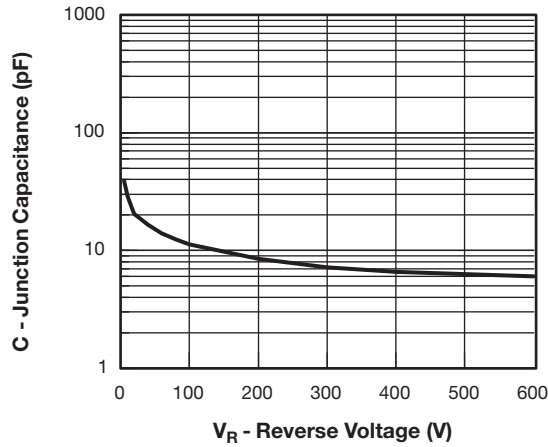


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

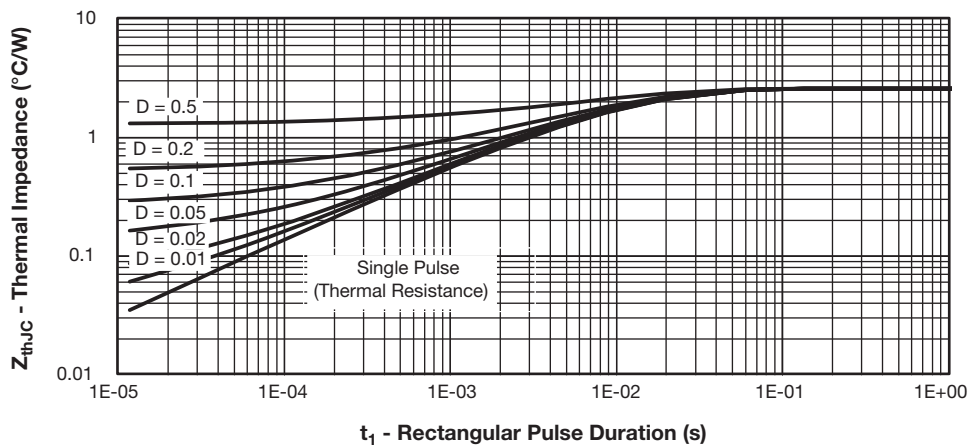


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

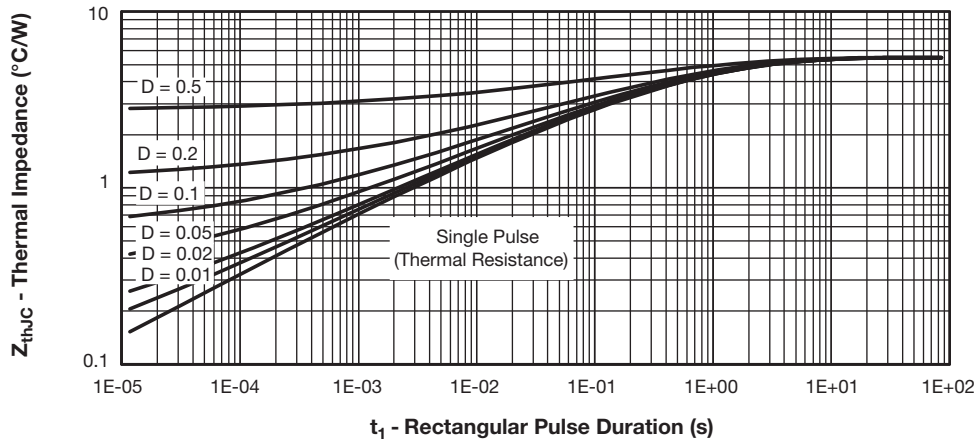


Fig. 5 - Maximum Thermal Impedance Z_{thJC} Characteristics (FULL-PAK)

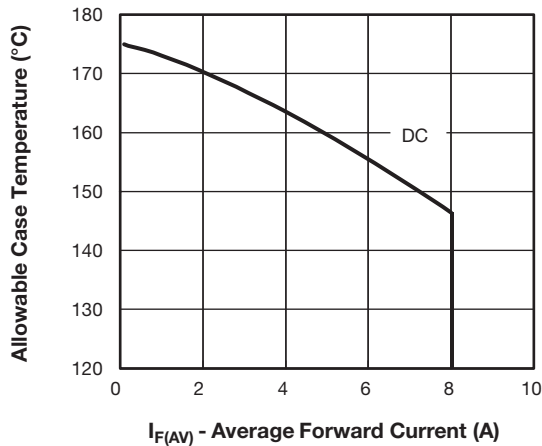


Fig. 6 - Maximum Allowable Case Temperature vs. Average Forward Current

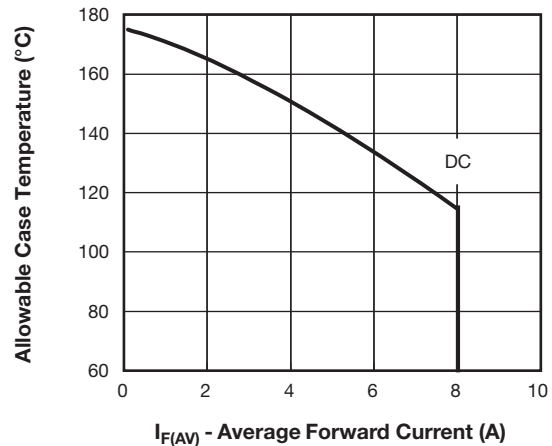


Fig. 7 - Maximum Allowable Case Temperature vs. Average Forward Current (FULL-PAK)

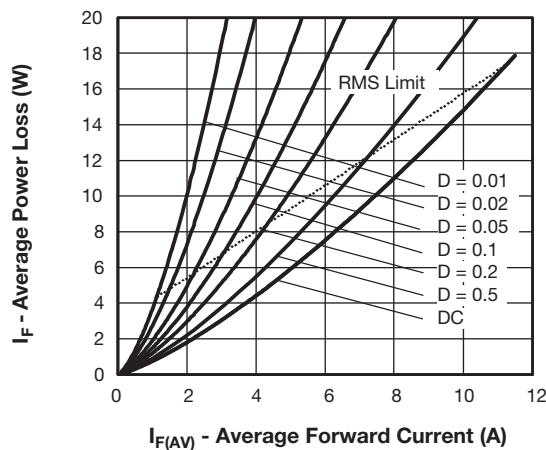


Fig. 8 - Forward Power Loss Characteristics

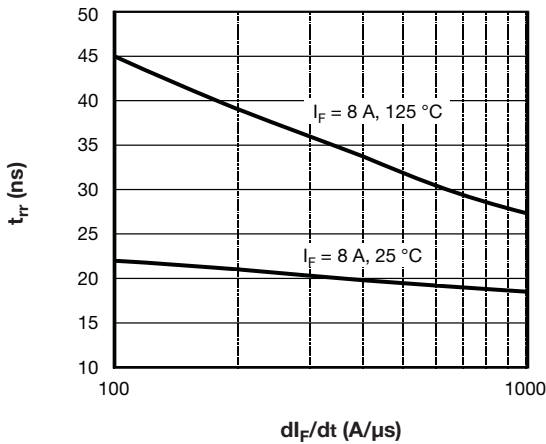


Fig. 9 - Typical Reverse Recovery vs. di_F/dt

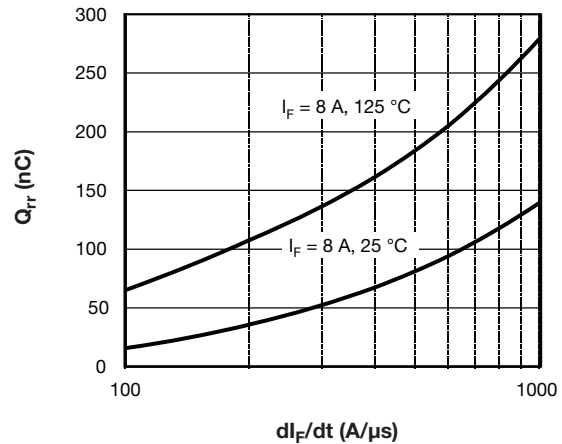


Fig. 10 - Typical Stored Charge vs. di_F/dt

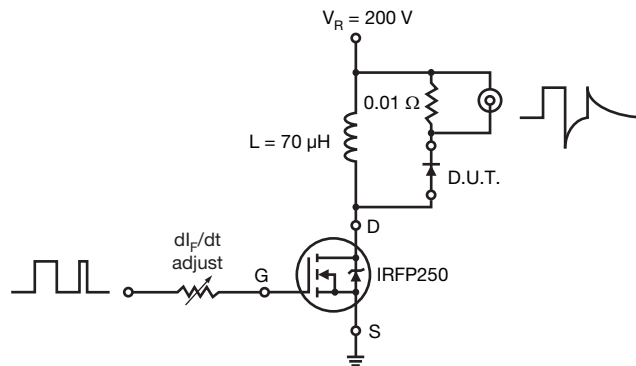
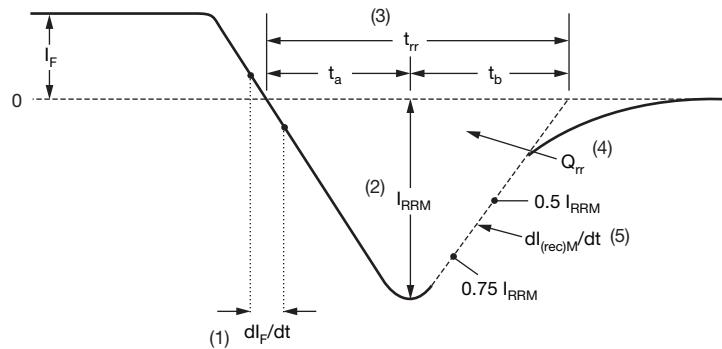


Fig. 11 - Reverse Recovery Parameter Test Circuit



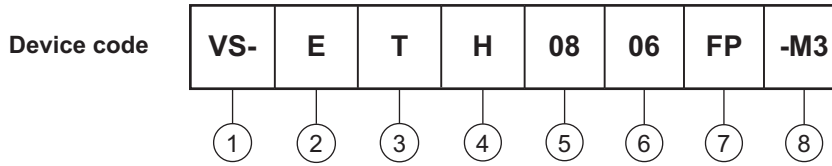
- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75 I_{RRM}$ and $0.50 I_{RRM}$ extrapolated to zero current.
- (4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}
- (5) $dl_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

Fig. 12 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Circuit configuration:
E = single diode
- 3** - T = TO-220
- 4** - H = hyperfast recovery time
- 5** - Current code: 08 = 8 A
- 6** - Voltage code: 06 = 600 V
- 7** -
 - None = TO-220
 - FP = FULL-PAK
- 8** - Environmental digit:
-M3 = halogen-free, RoHS-compliant and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|--------------------------------|-------------------|------------------------|-------------------------|
| PREFERRED P/N | QUANTITY PER TUBE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-ETH0806-M3 | 50 | 1000 | Antistatic plastic tube |
| VS-ETH0806FP-M3 | 50 | 1000 | Antistatic plastic tube |

| LINKS TO RELATED DOCUMENTS | | | |
|----------------------------|--------------------|--|--|
| Dimensions | 2L TO-220AC | www.vishay.com/doc?95259 | |
| | 2L TO-220 FULL-PAK | www.vishay.com/doc?95260 | |
| Part marking information | 2L TO-220AC | www.vishay.com/doc?95391 | |
| | 2L TO-220 FULL-PAK | www.vishay.com/doc?95392 | |

True 2 Pin TO-220

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIMETERS | | INCHES | |
|-------------------------------|-------------|-------|-----------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| A | 4.32 | 4.57 | 0.170 | 0.180 |
| b | 0.71 | 0.91 | 0.028 | 0.036 |
| b ₁ | 1.15 | 1.39 | 0.045 | 0.055 |
| c | 0.36 | 0.53 | 0.014 | 0.021 |
| D | 14.99 | 15.49 | 0.590 | 0.610 |
| E | 10.04 | 10.41 | 0.395 | 0.410 |
| e | 5.08 BSC | | 0.200 BSC | |
| F | 1.22 | 1.37 | 0.048 | 0.054 |
| H ₁ | 5.97 | 6.47 | 0.235 | 0.255 |
| J ₁ | 2.54 | 2.79 | 0.100 | 0.110 |
| L | 13.47 | 13.97 | 0.530 | 0.550 |
| L ₁ ⁽¹⁾ | 3.31 | 3.81 | 0.130 | 0.150 |
| Ø P | 3.79 | 3.88 | 0.149 | 0.153 |
| Q | 2.60 | 2.84 | 0.102 | 0.112 |

Notes

⁽¹⁾ Lead dimension and finish uncontrolled in L₁

- These dimensions are within allowable dimensions of JEDEC TO-220AB rev. J outline dated 3-24-87
- Controlling dimension: Inch



True 2 Pin TO-220 FULL-PAK

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIMETERS | | INCHES | |
|----------------|--------------|-------|---------------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| A | 4.53 | 4.93 | 0.178 | 0.194 |
| b | 0.71 | 0.91 | 0.028 | 0.036 |
| b ₁ | 1.15 | 1.39 | 0.045 | 0.055 |
| C | 0.36 | 0.53 | 0.014 | 0.021 |
| D | 15.67 | 16.07 | 0.617 | 0.633 |
| E | 9.96 | 10.36 | 0.392 | 0.408 |
| e | 5.08 typical | | 0.200 typical | |
| F | 2.34 | 2.74 | 0.092 | 0.107 |
| H ₁ | 6.50 | 6.90 | 0.256 | 0.272 |
| J ₁ | 2.56 | 2.96 | 0.101 | 0.117 |
| L | 12.78 | 13.18 | 0.503 | 0.519 |
| L ₁ | 2.23 | 2.63 | 0.088 | 0.104 |
| Ø Q | 2.98 | 3.38 | 0.117 | 0.133 |
| Q ₁ | 3.10 | 3.50 | 0.122 | 0.138 |
| Q ₂ | 14.80 | 15.20 | 0.583 | 0.598 |
| θ | 0° | 5° | 0° | 5° |



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